Silicon PNP Epitaxial

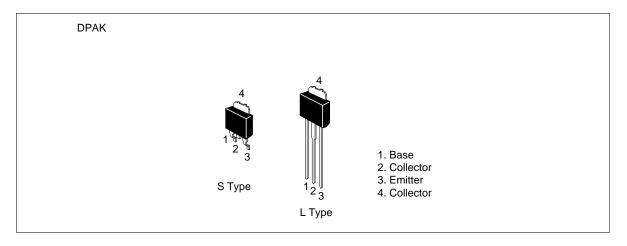
HITACHI

ADE-208-876 (Z) 1st. Edition Sep. 2000

Application

Low frequency power amplifier complementary Pair with 2SD2121(L)/(S)

Outline





Absolute Maximum Ratings (Ta = 25° C)

Item	Symbol	Ratings	Unit
Collector to base voltage	V _{CBO}	-35	V
Collector to emitter voltage	V _{CEO}	-35	V
Emitter to base voltage	V _{EBO}	-5	V
Collector current	Ι _c	-2.5	А
Collector peak current	I _{C(peak)}	-3	А
Collector power dissipation	P _c * ¹	18	W
Junction temperature	Tj	150	٥C
Storage temperature	Tstg	-55 to +150	°C
	,		

Note: 1. Value at $T_c = 25^{\circ}C$.

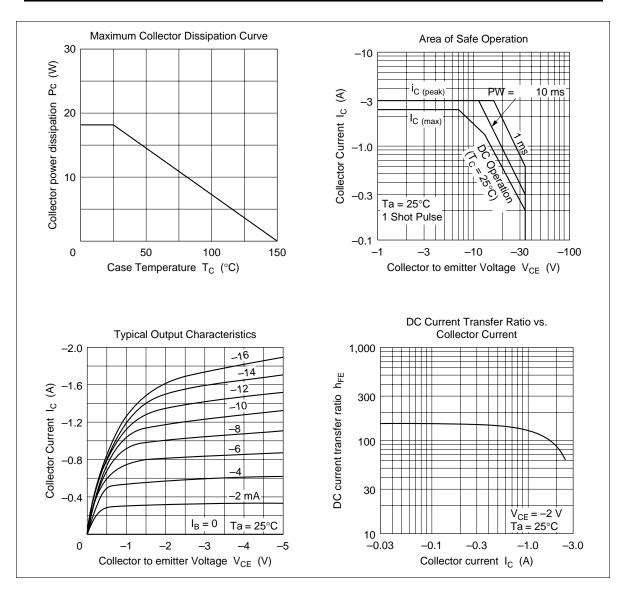
Electrical Characteristics (Ta = 25°C)

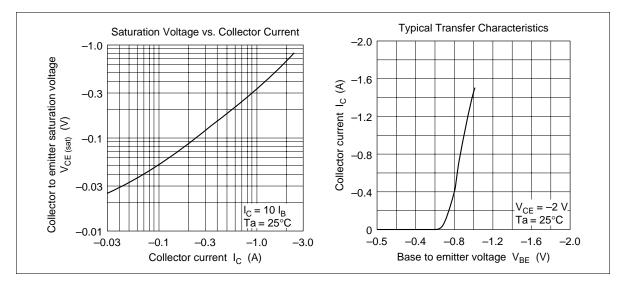
Item	Symbol	Min	Тур	Мах	Unit	Test conditions
Collector to base breakdown voltage	$V_{\rm (BR)CBO}$	-35	_	_	V	$I_{c} = -1 \text{ mA}, I_{E} = 0$
Collector to emitter breakdown voltage	$V_{\rm (BR)CEO}$	-35	_	_	V	$I_c = -10 \text{ mA}, \text{ R}_{\text{BE}} = \infty$
Emitter to base breakdown voltage	$V_{(\text{BR})\text{EBO}}$	-5	—	_	V	$I_{\rm E} = -1 {\rm mA}, I_{\rm C} = 0$
Collector cutoff current	I _{CBO}	_	—	-20	μΑ	$V_{\rm CB} = -35 \text{ V}, \text{ I}_{\rm E} = 0$
DC current transfer ratio	h_{FE1}^{*1}	60		320		$V_{ce} = -2 V, I_c = -0.5 A^{*2}$
	\mathbf{h}_{FE2}	20	_	—		$V_{ce} = -2 V, I_c = -1.5 A^{*2}$
Base to emitter voltage	V_{BE}	—		-1.5	V	$V_{ce} = -2 V, I_c = -1.5 A^{*2}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	—	_	-1.0	V	$I_{\rm c} = -2$ A, $I_{\rm B} = -0.2$ A* ²

Notes: 1. The 2SB1407(L)/(S) is grouped by h_{FE1} as follows.

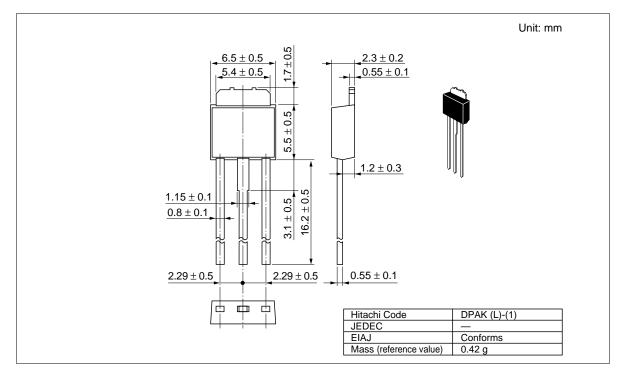
В	С	D
60 to 120	100 to 200	160 to 320

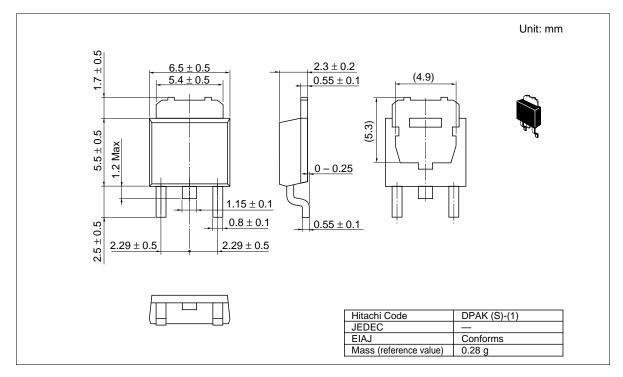
2. Pulse test.





Package Dimensions





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